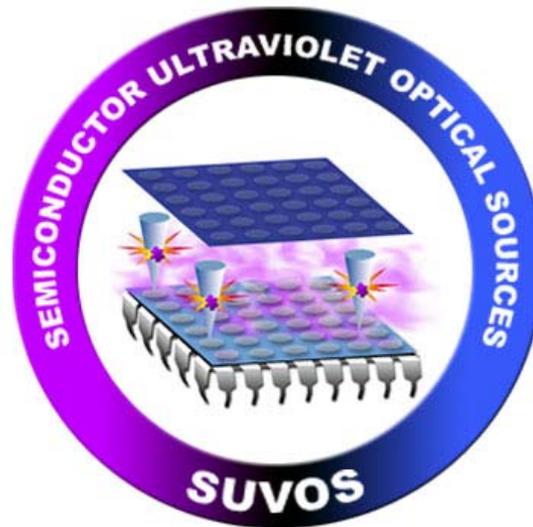


Semiconductor Ultraviolet Optical Sources



LTC John C. Carrano, Ph.D.

Program Manager

DARPA

Microsystems Technology Office



Microsystems Technology Office

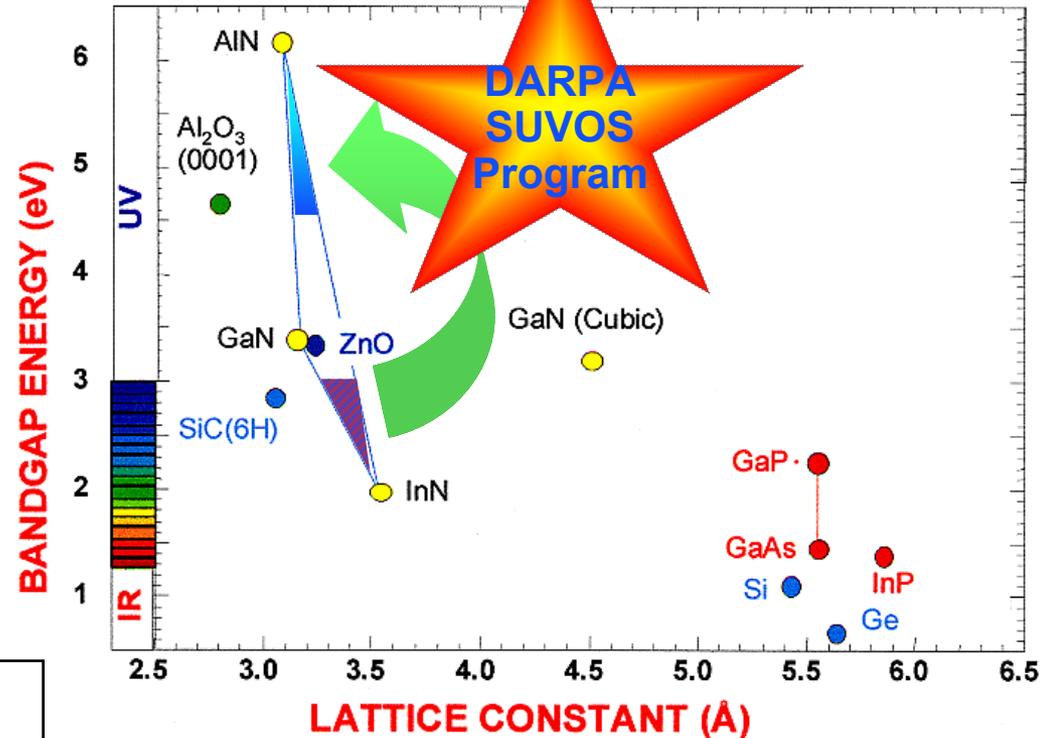
Wide Bandgap Photonics Technology

Program Goals:

- ❖ Demonstrate semiconductor UV optical sources ($\lambda = 280$ nm).
- ❖ Compared to current non-semiconductor approaches
 - Reduce power consumption by 50x
 - Reduce size/weight by >100x

Program Challenges:

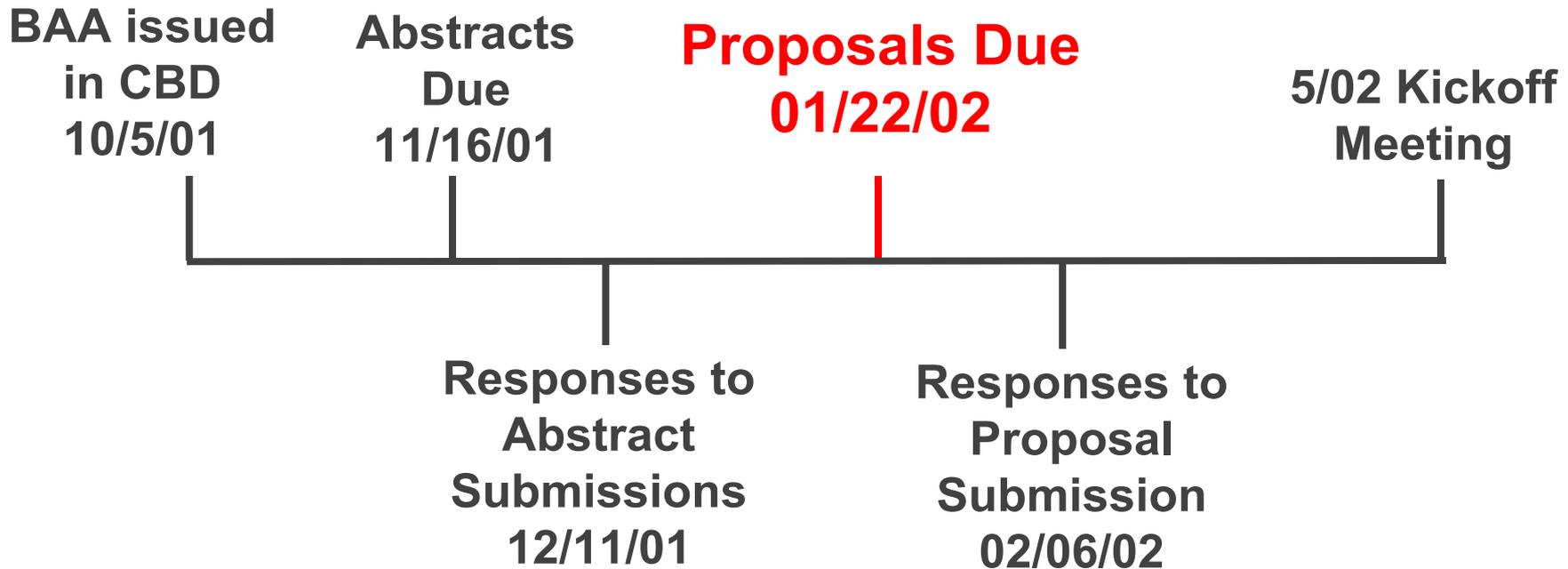
- ❖ *p*-type conductivity of UV materials
- ❖ Device Innovation
 - Suppress non-radiative recombination
 - Epitaxial uniformity and strain management
- ❖ Microsystem prototype development



Military Applications:

- ❖ *Biological Agent Threat Warning*
- ❖ **NLOS Covert Communications**

BAA Timeline



Thrust Areas

- ❖ UV Photonic Materials Development
 - Exploitation of III-Nitride based semiconductors
 - High aluminum content material (280 nm active regions)
 - Epitaxial uniformity
 - Other novel approaches (e.g. organics, phosphors)
- ❖ UV Emitters (LED's and Laser Diodes)
 - Initial development of 340 nm emitters
 - Final goal is 280 nm semiconductor optical sources
 - LED's and laser diodes of interest
 - OLED's, field emitters, others
- ❖ Testbed Development and Demonstrations
 - Biological agent detection
 - NLOS covert communications



Program Phases

- ❖ Phase I Goals (24 Months)
 - Develop UV photonic materials
 - Optoelectronic device innovation
- ❖ Phase II Goals (two 12 Month periods)
 - Optimization of UV photonic materials
 - Demonstration of UV optical sources (280 nm)
 - Testbed development and demonstrations
 - Biological Agent Detection
 - NLOS Covert Communications
- ❖ Milestones and Metrics
 - Established timelines for demonstrations/deliverables
 - Clearly stated metrics (exit criteria)
 - Acceptable range of performance
 - Highlight “show-stopper” criteria



Vertical Integration of Teams

- ❖ Primary DARPA interest is in comprehensive teams to address all program goals.
- ❖ Some individual performer efforts considered
- ❖ Visit the SUVOS teaming website



Government Lab Involvement

- ❖ Do not include gov't labs as part of BAA submission
- ❖ Willingness to provide deliverables to gov't labs as designated by DARPA PM.



Evaluation Criteria

- ❖ Overall scientific and technical merit
- ❖ Potential contribution and relevance to DARPA mission
- ❖ Plans and capability to accomplish technology transition
- ❖ Offeror's capabilities and related experience
- ❖ Cost realism



Performance Goals

- ❖ Wavelength: 340nm → 280nm
- ❖ Devices: LED's and Laser Diodes
- ❖ Power: Milliwatts of optical output
- ❖ Operation: Pulsed and CW (RT)
- ❖ Efficiency: High External Q.E.
- ❖ $V_{\text{turn-on}}$: Low voltage
- ❖ Lifetime: >10,000 hours



Current Limitations and Program Goal

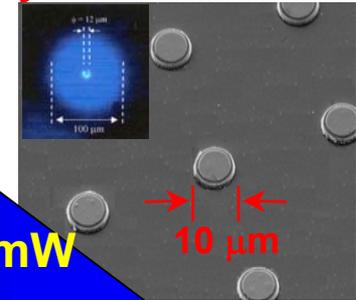
Laser Head



Power Supply



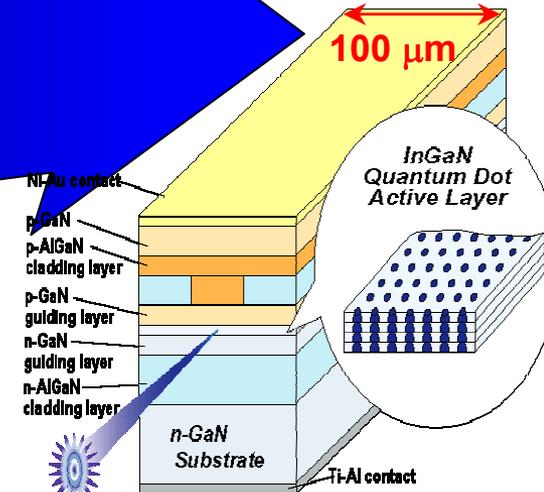
Vertical cavity surface emitter arrays



- ❖ Consumed power: 25 W → 100mW
- ❖ Size: 500 cm³ → 1 cm³
- ❖ Weight: 4 Kg → 2 g
- ❖ Cost: \$10K → \$100

Reduction

Reduction



Edge emitters

PROGRAM DELIVERABLES

Non-Line of Sight Covert Comms:

- ❖ 280 nm LED's (< 10 mW)
- ❖ Transceiver Test bed

Bio-Detection:

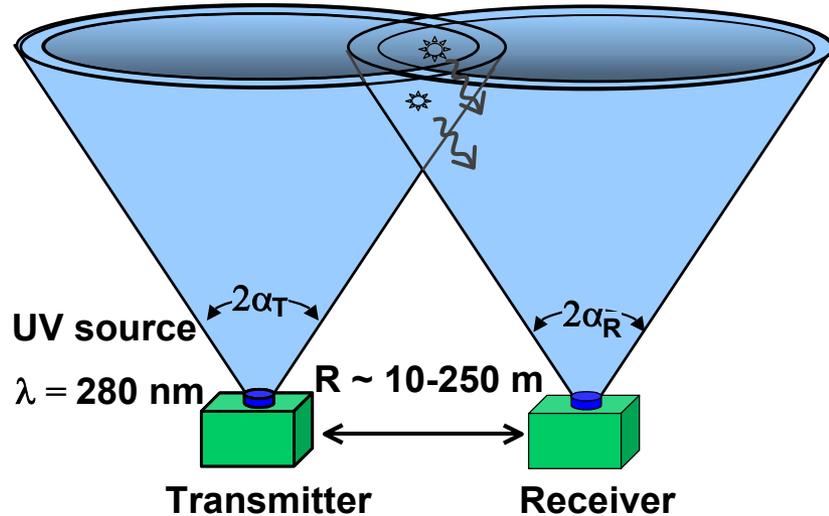
- ❖ 280 nm LED's (< 10 mW)
- ❖ 340 nm Laser Diodes (< 25 mW)
- ❖ Microsystem Test bed



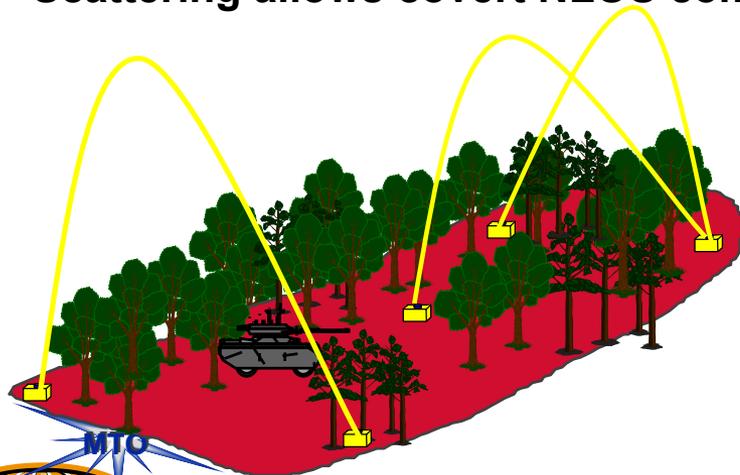
Emitter Power Source

Military Impact

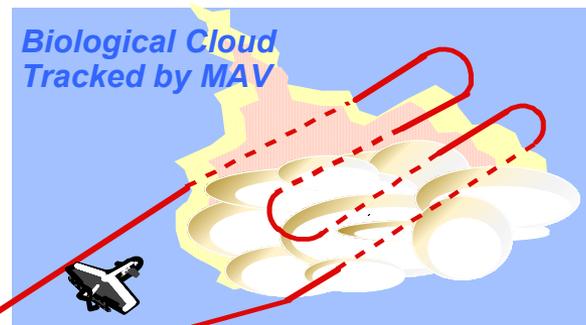
Aerosol & molecular scattering



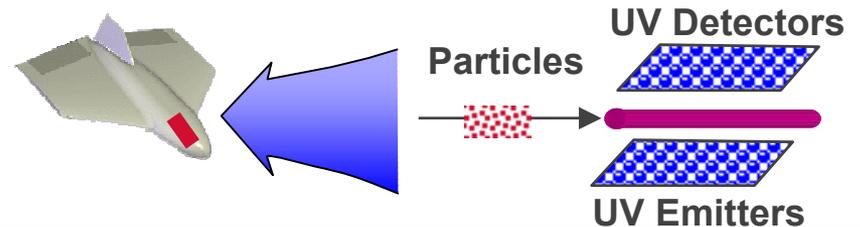
- ❖ Transceiver is a chip-scale microsystem
- ❖ Scattering allows covert NLOS comms



From Shaw et al., 2000



Remote Detection & LIDAR



Technology Nuggets

Challenges

Solutions

❖ *p*-type Conductivity

❖ Device Innovation

- Suppress non-radiative recombination
- Strain management

❖ Large Band Offsets

- Reduce turn-on voltage
- Enhance carrier transport



Program Plan

- ❖ **Task 1: UV Materials Development**
 - p -type doping (and ohmic contact development)
 - Optical gain (active region development)
 - Band-gap engineered heterostructures

- ❖ **Task 2: Device Innovation**
 - 340 nm LED and Laser Diode (NADH)
 - 280 nm LED (Amino Acids, Comms)

- ❖ **Task 3: Integration and Demonstration**
 - Transceiver test bed
 - Bio-detection test bed



Task 1: UV Materials Development

- ❖ Research Challenges:
 - Improve p-type Conductivity
 - Reduce Operating Voltage
 - Enhance Radiative Efficiency
 - Ohmic contact optimization



Task 2: Device Innovation

❖ Research Challenges:

- Novel structures
- Cavity Optimization
- Light Extraction through GaN contact layers
- Uniformity and reproducibility
- Current Injection techniques
- Thermal Management
- Strain and Cracking



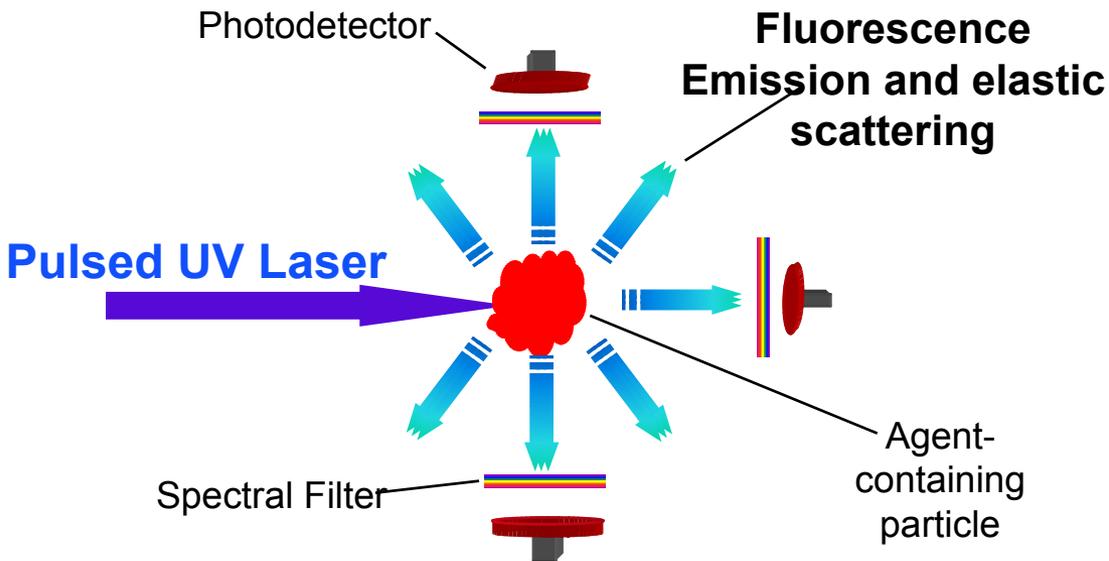
Task 3: Integration and Demonstration

❖ Research Challenges

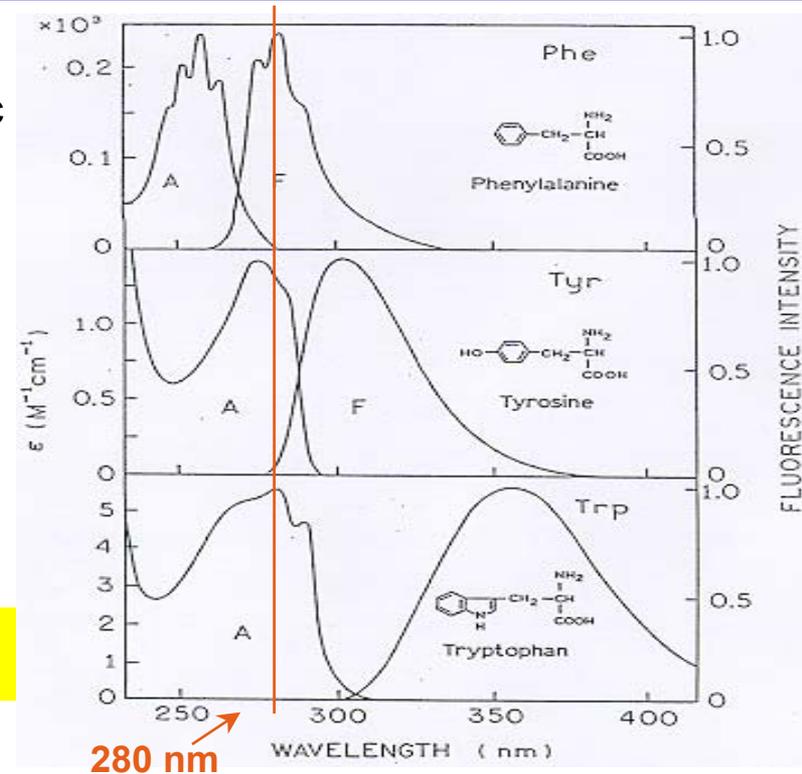
- Transceiver test bed development
- Biological agent detection test bed
- Heterogeneous Integration



Laser Induced Fluorescence



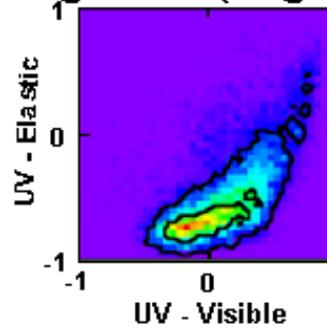
Laser Induced Fluorescence



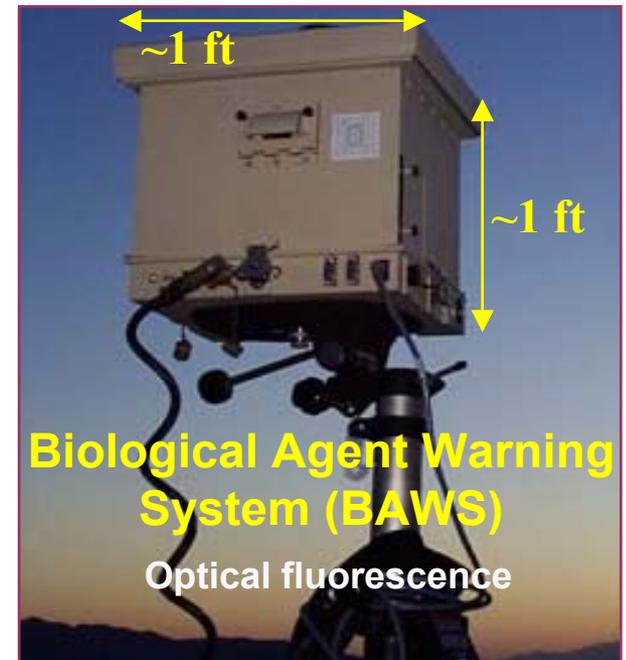
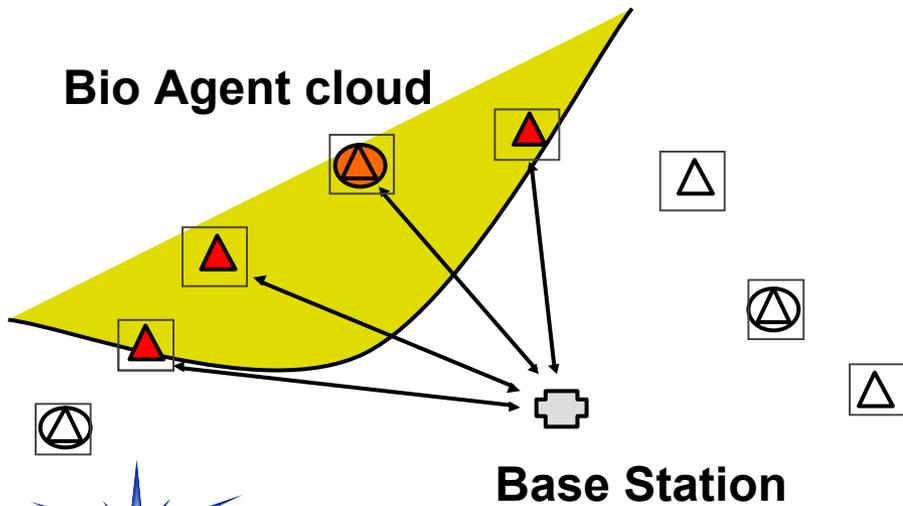
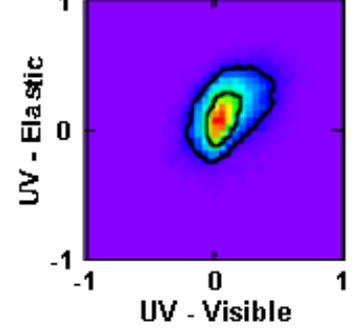
Military Impact (Bio-Sensing)

DoD needs revolutionary technologies to enable the miniaturization of bio-detectors

Background Signature (Dugway)



Simulant Signature (BG)



Future Enabled NBC Applications

Short Range
LIDAR

Offers greater tactical flexibility
to the commander in the field

Point Detection

